ASSOCIATION CONNEC	Material Comp © Copyright 2005. Il international and Par	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					laterials and	ials and Mfg Information			
Supplier Info	rmation														
Company name* Company unique ID					Unique ID Authority					Respo	Response Date*				
nsemi										2024-	2024-04-25				
Contact Name		Title - Contact			P	Phone - Contact*				Emai	Email - Contact*				
Product-Env-Ste	ewards	Product Enviro Compliance			1	NA				Prod	Product-Env-Stewards@onsemi.com				
uthorized Repr	esentative*	Title - Representative			P	Phone - Representative*				Emai	Email - Representative*				
Product-Env-Stewards Produ				Product Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com			
Reque	Requester Item Number		Mfr Item Number Mfr Item Name			Effe		Version		Manufacturing Site		Weight*	UOM	Unit Type	
		NCS36510MNTXG Low Power Syste IEEE 802.15.4-20		em-on-Chip for 2.4	4 GHz	2024-04-25	4-25 PHG			118.43	mg	Each			
<b>Ianufacturi</b> n	ng Proccess Informa	tion													
Terminal Plating / Grid Array Material T			Ferminal Base Alloy J-STD-020 MS		J-STD-020 MSL I	Rating	Peak Process Body Temperature   Max Time at Pea			Peak Tempe	k Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed		CU Alloy 3		3		260		С	30	sec	conds 3				
omments															
TTENTION: M	ISL 3 Rated item require	s Bake and L	Ory Pack (afte	r electrical test)											
or more inform	ation regarding material	composition	please refer to	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appli											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.86	mg	Supplier	Silicon (Si)	7440-21-3		4.86	mg
Die Attach	1.15	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.23	mg
			Supplier	Silver (Ag)	7440-22-4		0.92	mg
Lead Frame	50.35	mg	Supplier	Silver (Ag)	7440-22-4		1.007	mg
			Supplier	Tin (Sn)	7440-31-5		0.1259	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1108	mg
			Supplier	Chromium (Cr)	7440-47-3		0.1259	mg
			Supplier	Copper (Cu)	7440-50-8		48.9805	mg
Mold Compound-Black	59.83	mg		Epoxy resin	proprietary data		2.812	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		5.983	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0598	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		48.1632	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.812	mg
Plating	1.44	mg	Supplier	Tin (Sn)	7440-31-5		1.44	mg
Wire Bond - Au	0.8	mg	Supplier	Gold (Au)	7440-57-5		0.8	mg